



RS2G126 Dual Bus Buffer Gate With 3-State Outputs

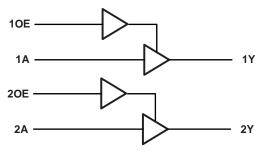
1 FEATURES

- Operating Voltage Range:1.65V to 5.5V
- Low Power Consumption:1µA (Max)
- Operating Temperature Range: -40°C to +125°C
- Inputs Accept Voltage to 5.5V
- ±24mA Output Drive at Vcc=3.0V
- Latch-up Performance Exceeds 100mA
- PACKAGE: MSOP-8

2 APPLICATIONS

- AV Receiver
- Cable Modem Termination Systems
- Digital Picture Frame (DPF)
- High-Speed Data Acquisition and Generation
- Motor Controls: High-Voltage
- Personal Navigation Device (GPS)
- Portable Media Player
- Video Communication Systems

Simplified Schematic



3 DESCRIPTIONS

The dual buffer is designed for 1.65V to 5.5V $V_{\rm CC}$ operation. The RS2G126 device is dual line drivers with 3-state output. The outputs are disabled when the output-enable input is low.

This device is fully specified for partial-power-down applications using loff. The loff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pulldown resistor, the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The RS2G126 is available in Green MSOP-8 and TSSOP-8 package. It operates over an ambient temperature range of -40°C to +125°C.

Device Information (1)

	PART NUMBER	PACKAGE	BODY SIZE (NOM)	
	RS2G126	MSOP-8	3.00mm×3.00mm	
		TSSOP-8	4.40mm×3.00mm	

⁽¹⁾ For all available packages, see the orderable addendum at the end of the data sheet.

4 FUNCTION TABLE

INP	OUTPUT		
OE	Α	Υ	
Н	Н	Н	
Н	L	L	
L	Х	Z	

H=HIGH Logic Level L =LOW Logic Level X=Don't Care



Table of Contents

1 FEATURES	
2 APPLICATIONS	1
3 DESCRIPTIONS	1
4 FUNCTION TABLE	1
5 Revision History	
6 PACKAGE/ORDERING INFORMATION (1)	4
7 PIN CONFIGURATIONS	5
8 Specifications	6
8.1 Absolute Maximum Ratings (1)	6
8.2 ESD Ratings	6
9 ELECTRICAL CHARACTERISTICS	7
9.1 Recommended Operating Conditions	7
9.2 DC Characteristics	7
9.3 Switching Characteristics, C _L =15pF	8
9.4 Switching Characteristics, C _L =30pF or 50pF	8
9.5 Operating Characteristics	8
10 Parameter Measurement Information	9
11 PACKAGE OUTLINE DIMENSIONS	10
12 TAPE AND REEL INFORMATION	12



5 Revision HistoryNote: Page numbers for previous revisions may different from page numbers in the current version.

Version	Change Date	Change Item
A.1	2021/02/05	Initial version completed
A.2	2021/12/22	Added the TAPE AND REEL INFORMATION
A.3	2022/09/01	Change TSSOP8 package to MSOP8 package Change ORDERING NUMBER
A.4	2022/10/28	Add TSSOP-8 package Change ESD Ratings



6 PACKAGE/ORDERING INFORMATION (1)

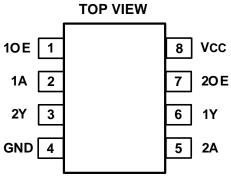
PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING (2)	PACKAGE OPTION
RS2G126	RS2G126XM	-40°C ~+125°C	MSOP-8	RS2G126	Tape and Reel,4000
R52G120	RS2G126XQ	-40°C ~+125°C	TSSOP-8	RS2G126	Tape and Reel,4000

NOTE:

- (1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.
- (2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.



7 PIN CONFIGURATIONS



MSOP-8/TSSOP-8

PIN DESCRIPTION

PIN	NAME	I/O TYPE (1)	FUNCTION		
MSOP-8/TSSOP-8	IVAIVIE	WOTTPE V	FONCTION		
1	10E	I	Output Enable for buffer 1		
2	1A	1	Input of buffer 1		
3	2Y	0	Output of buffer 2		
4	GND	-	Ground		
5	2A	I	Input of buffer 2		
6	1Y	0	Output of buffer 1		
7	20E	I	Output Enable for buffer 2		
8	Vcc	-	Power Pin		

⁽¹⁾ I=input, O=output.



8 Specifications

8.1 Absolute Maximum Ratings (1)

over operating free-air temperature range (unless otherwise noted) (1) (2)

			MIN	MAX	UNIT
Vcc	Supply voltage range	-0.5	6.5	V	
Vı	Input voltage range (2)		-0.5	6.5	V
Vo	Voltage range applied to any output in the high-im	npedance or power-off state (2)	-0.5	6.5	V
Vo	Voltage range applied to any output in the high or	low state (2) (3)	-0.5	Vcc+0.5	V
lıĸ	Input clamp current	V _I <0		-50	mA
Іок	Output clamp current	Vo<0		-50	mA
lο	Continuous output current			±50	mA
	Continuous current through Vcc or GND			±100	mA
θ_{JA}	Package thermal impedance (4)	MSOP-8		165.7	°C/W
UJA	TSSOP-8			240	C/VV
TJ	Junction temperature (5)		-65	150	°C
T _{stg}	Storage temperature		-65	150	°C

⁽¹⁾ Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of V_{CC} is provided in the Recommended Operating Conditions table.
- (4) The package thermal impedance is calculated in accordance with JESD-51.
- (5) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.

8.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

			VALUE	UNIT
V(zop)	V _(ESD) Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±4000	V
V (ESD)		Machine model (MM)	±500	V

⁽¹⁾ JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process.



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

6 / 13 www.run-ic.com



9 ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (TYP values are at $T_A = +25$ °C, unless otherwise noted.) (1)

9.1 Recommended Operating Conditions

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT	
Cupply voltage	\/	Operating	1.65	5.5	V	
Supply voltage	Vcc	Data retention only	1.5	5.5	_ v	
		V _{CC} =1.65V to 1.95V	0.65xVcc			
High lavel is mut valtage	\ <i>/</i>	V _{CC} =2.3V to 2.7V	1.7		V	
High-level input voltage	V_{IH}	V _{CC} =3V to 3.6V	2.2		V	
		V _{CC} =4.5V to 5.5V	0.7xVcc			
	VIL	V _{CC} =1.65V to 1.95V		0.15xVcc		
Low lovel input veltage		V _{CC} =2.3V to 2.7V		0.3	V	
Low-level input voltage		V _{CC} =3V to 3.6V		0.4	_ v	
		V _{CC} =4.5V to 5.5V		0.15xVcc		
Input voltage	Vı		0	5.5	V	
Output voltage	Vo		0	Vcc	V	
		V _{CC} =1.8V± 0.15V, 2.5V± 0.2V		20		
Input transition rise or fall	t _r , t _f	V _{CC} =3.3V± 0.3V		10	ns/V	
		V _{CC} =5V± 0.5V		5	=	
Operating temperature	TA		-40	+125	°C	

9.2 DC Characteristics

Р	ARAMETER	TEST CONDITIONS	Vcc	TEMP	MIN ⁽²⁾	TYP ⁽³⁾	MAX ⁽²⁾	UNIT
		Іон = -100μΑ	1.65V to 5.5V		V _{CC} - 0.1			
Voн		I _{OH} = -4mA	1.65V		1.2			
		I _{OH} = -8mA	2.3V	Full	1.9			
	3 611	I _{OH} = -16mA	2)/		2.4			-
		I _{OH} = -24mA	3V		2.3			
		I _{OH} = -32mA	4.5V		3.8			
		I _{OL} = 100μA	1.65V to 5.5V				0.1	
		I _{OL} = 4mA	1.65V				0.45	V
	V	I _{OL} = 8mA	2.3V	Full			0.3	
	V _{OL}	I _{OL} = 16mA	- 3V				0.4	
		$I_{OL} = 24mA$					0.55	
		I _{OL} = 32mA	4.5V		0.55			
1.	A or OE inputs	V 5 5V OND	0V to 5.5V	+25°C		±0.1	±1	
l _l	A or OE inputs	V _I =5.5V or GND		Full			±5	μA
	1	\/.or\/-	0V	+25°C		±0.1	±1	
I_{off}		V _I or V _O =5.5V	UV	Full			±10	μΑ
loz Icc		Vo=0V to 5.5V	3.6V	Full			10	μΑ
		VE EV or CND 10	1.65\/ to 5.5\/	+25°C		0.1	1	
		V _I =5.5V or GND, I _O =0	1.65V to 5.5V	Full			10	μA
	Δlcc	One input at V _{CC} -0.6V, Other inputs at V _{CC} or GND	3V to 5.5V	Full			500	μA



9.3 Switching Characteristics, C_L=15pF

over recommended operating free-air temperature range (-40°C to 125°C, unless otherwise noted.) (1)

PARAMETER	FROM (INPUT)	то	V _{CC} =1.8V±0.15V	V _{CC} =2.5V±0.2V	V _{CC} =3.3V±0.3V	V _{CC} =5V±0.5V	UNIT
PARAMETER		(OUTPUT)	TYP	TYP	TYP	TYP	UNII
t _{pd}	Α	Υ	6.1	3.7	3.9	2.1	ns

9.4 Switching Characteristics, C_L=30pF or 50pF

over recommended operating free-air temperature range (-40°C to 125°C, unless otherwise noted.) (1)

DADAMETED	FROM	то	Vcc=1.8V±0.15V	Vcc=2.5V±0.2V	Vcc=3.3V±0.3V	Vcc=5V±0.5V	LINUT
PARAMETER	(INPUT)	(OUTPUT)	TYP	TYP	TYP	TYP	UNIT
t _{pd}	Α	Y	8.6	5.3	4.0	2.9	ns
t _{en}	OE	Y	9.5	5.8	5.0	3.3	ns
t _{dis}	OE	Y	7.4	4.3	4.4	3.0	ns

9.5 Operating Characteristics $T_A=25^{\circ}C$

PARAMETER			TEST	Vcc=1.8V	Vcc=2.5V	Vcc=3.3V	Vcc=5V	UNIT
PARAMETER		CONDITIONS	TYP	TYP	TYP	TYP	UNIT	
C _{pd} Power dissipation		Output enabled	f=10MHz	18	18	18	21	pF
Opd	capacitance	Output disabled	I= IOWIHZ	2	2	3	4	рг

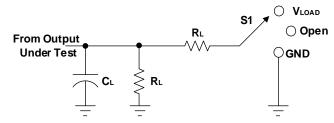
⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

⁽²⁾ Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.

⁽³⁾ Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.

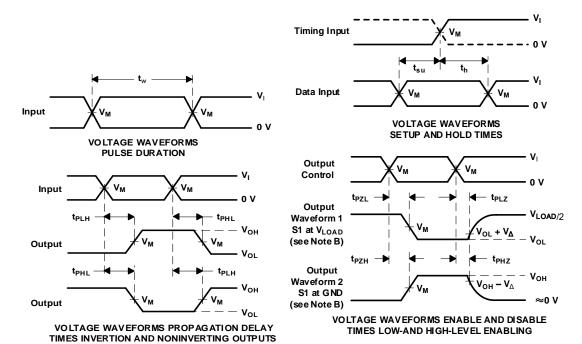


10 Parameter Measurement Information



TEST	S1					
t _{PLH} /t _{PHL}	Open					
t _{PLZ} /t _{PZL}	V_{LOAD}					
t _{PHZ} /t _{PZH}	GND					

V	INPUTS		V	V	CL		В		٧.
Vcc	Vı	t _r /t _f	V _M	VLOAD		•L	R∟		VΔ
1.8V±0.15V	Vcc	≤2ns	Vcc/2	2 x Vcc	15pF	30pF	1ΜΩ	1kΩ	0.15V
2.5V±0.2V	Vcc	≤2ns	V _{CC} /2	2 x V _{CC}	15pF	30pF	1ΜΩ	500Ω	0.15V
3.3V±0.3V	3V	≤2.5ns	1.5V	6V	15pF	50pF	1ΜΩ	500Ω	0.3V
5V±0.5V	Vcc	≤2.5ns	Vcc/2	2 x Vcc	15pF	50pF	1ΜΩ	500Ω	0.3V



NOTES: A. C_L includes probe and jig capacitance.

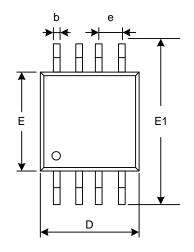
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_0 = 50~\Omega$.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

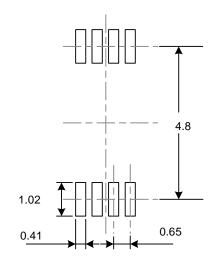
Figure 1. Load Circuit and Voltage Waveforms

9 / 13 www.run-ic.com

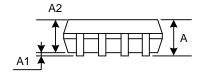


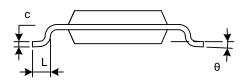
11 PACKAGE OUTLINE DIMENSIONS MSOP-8





RECOMMENDED LAND PATTERN (Unit: mm)

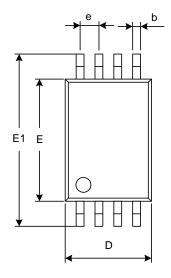


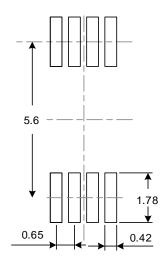


Course la cal	Dimensions I	n Millimeters	Dimensions In Inches			
Symbol	Min	Max	Min	Max		
А	0.820 1.100		0.032	0.043		
A1	0.020	0.150	0.001	0.006		
A2	0.750	0.950	0.030	0.037		
b	0.250 0.380		0.010	0.015		
С	0.090	0.230	0.004	0.009		
D	2.900	3.100	0.114	0.122		
е	0.650(BSC)		0.026	(BSC)		
Е	2.900	3.100	0.114	0.122		
E1 4.750		5.050	0.187	0.199		
L	L 0.400		0.016	0.031		
θ	θ 0°		0°	6°		

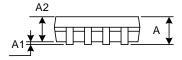


TSSOP-8





RECOMMENDED LAND PATTERN (Unit: mm)





Coursels of	Dimensions	In Millimeters	Dimensions In Inches			
Symbol	Min	Max	Min	Max		
А		1.200		0.047		
A1	0.050	0.150	0.002	0.006		
A2	0.800	1.050	0.031	0.041		
b	0.190	0.300	0.007	0.012		
С	0.090	0.200	0.004	0.008		
D	D 2.900		0.114	0.122		
E	4.300	4.500	0.169	0.177		
E1	E1 6.250		6.550 0.246			
е	0.650	(BSC)	0.026	(BSC)		
L 0.500		0.700	0.020	0.028		
Н	0.25((TYP)	0.01(TYP)			
θ	1°	7°	1°	7°		

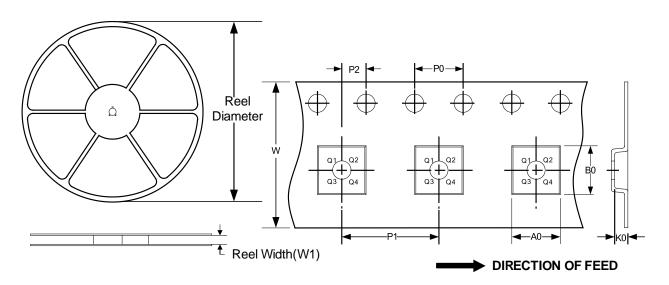
NOTE:

- A. All linear dimension is in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 D. BSC: Basic Dimension. Theoretically exact value shown without tolerances.



12 TAPE AND REEL INFORMATION REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width(mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
MSOP-8	13"	12.4	5.20	3.30	1.50	4.0	8.0	2.0	12.0	Q1
TSSOP-8	13"	12.4	6.90	3.45	1.65	4.0	8.0	2.0	12.0	Q1

NOTE:

- 1. All dimensions are nominal.
- 2. Plastic or metal protrusions of 0.15mm maximum per side are not included.



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